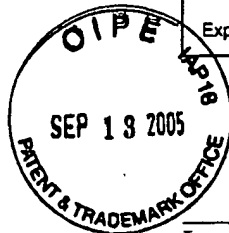


09-15-05

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Docket No.: 20196/0200734-US0
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Erik Heinemann et al.

Application No.: 10/762,882

Confirmation No.: 5436

Filed: January 21, 2004

Art Unit: 2841

For: MAKING CONTACT WITH
SEMICONDUCTOR CHIPS IN CHIP CARDS

Examiner: H. S. Bui

*pls, enter
H2 10/31/05*

AMENDMENT UNDER 37 C.F.R. 1.312)

MS Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to issuance of the patent, applicant respectfully requests entry on this amendment under 37 C.F.R. 1.312 for the above-captioned patent application.

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.